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CENTRAL FAX CENTER****MAR 13 2007****IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant(s): Liu

Application No.: 10/634,964

Filed: 8/5/2003

Title: CHEMICAL MECHANICAL
PLANARIZATION COMPOSITIONS FOR
REDUCING EROSION IN SEMICONDUCTOR
WAFERSArt Unit:
1765Examiner:
Patricia A. George

Attorney Docket No.: 02039US

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

RESPONSE AFTER FINAL REJECTION

Dear Sir:

In response to the Office Action of February 5, 2007, having a shortened statutory
deadline of May 5, 2007, please amend the specification as follows.